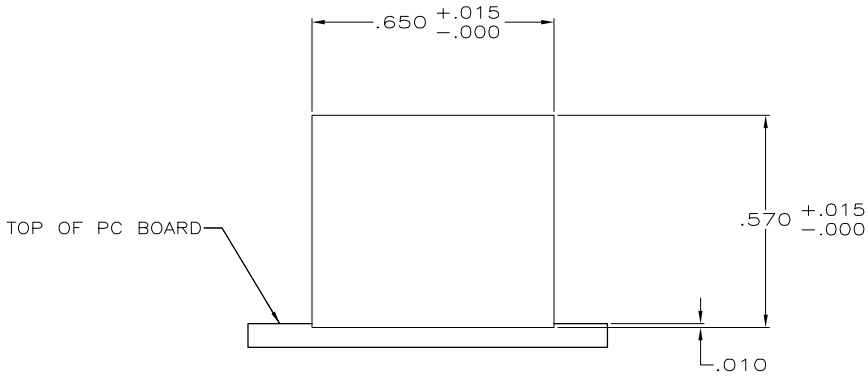
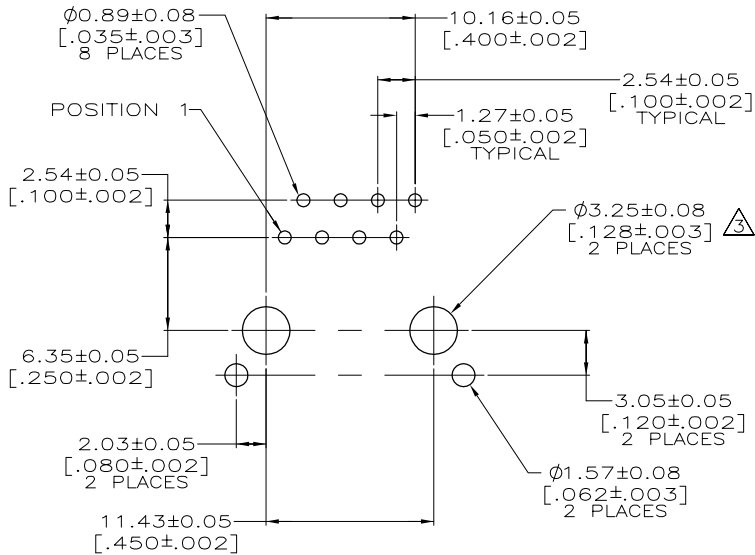
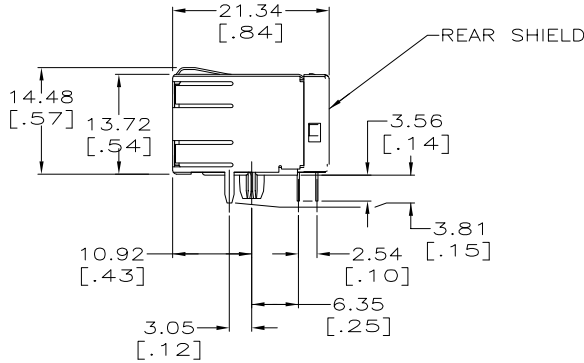
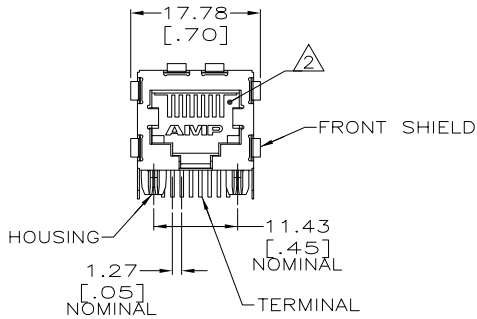


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LOC	DIST	REVISIONS				
		P	LTR	DESCRIPTION	DATE	DWN
AA	22	B1		REV PER ECR-09-004284	16APR2009	TY SY

- 1 MATERIAL: HOUSING - NYLON, BLACK, IR REFLOW COMPATIBLE, UL 94V-0.
TERMINALS - 0.33[.013] THICK PHOS BRONZE PLATED WITH 1.27 μ m[.000050] MINIMUM THICK HARD GOLD IN LOCALIZED AREA AND 3.81 μ m[.000150] MINIMUM THICK MATTE TIN IN SOLDER AREA OVER 1.27 μ m[.000050] MINIMUM THICK NICKEL UNDERPLATE.
SHIELDS - 0.25[.010] THICK COPPER ALLOY PLATED WITH 1.27 μ m[.000050] MINIMUM NICKEL AND 2.03 μ m[.000080] MINIMUM HOT TIN DIP ON PCB GROUND TABS.
- △ JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.
- △ USE #30 DRILL BIT OR 3.25mm DRILL BIT WHEN PRODUCING THESE PCB HOLES.



SUGGESTED PANEL CUTOUT
SCALE 4:1

SUGGESTED PC BOARD LAYOUT
COMPONENT SIDE (TOP)
SCALE 4:1

THIS DRAWING IS A CONTROLLED DOCUMENT.				5406295-1 PART NUMBER			
DIMENSIONS: mm				Tyco Electronics Corporation Harrisburg, Pa 17105-3608			
TOLERANCES UNLESS OTHERWISE SPECIFIED: 0 PLC ± - 1 PLC ± - 2 PLC ± 0.25[.01] 3 PLC ± 0.13[.005] 4 PLC ± - ANGLES ± -				NAME MODULAR JACK ASSEMBLY, SINGLE PORT, 8 POSITION, SHIELDED, REVERSE PANEL GROUND TABS, CATEGORY 4			
MATERIAL SEE NOTE 1				SIZE A2			
FINISH SEE NOTE 1				CAGE CODE 00779			
CUSTOMER DRAWING				DRAWING NO 114-2048			
				RESTRICTED TO B1			
				SCALE 2:1			
				SHEET 1 OF 1			
				REV B1			